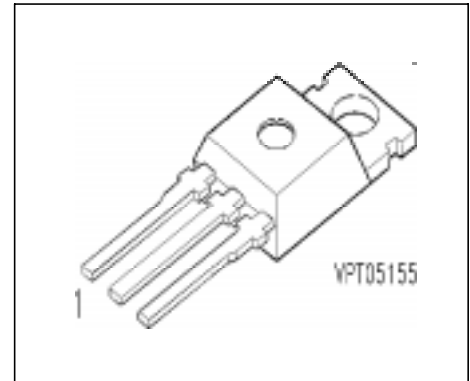


### IGBT With Antiparallel Diode

Preliminary data

- Low forward voltage drop
- High switching speed
- Low tail current
- Latch-up free
- Including fast free-wheel diode



Pin 1	Pin 2	Pin 3
G	C	E

Type	$V_{CE}$	$I_C$	Package	Ordering Code
BUP 400D	600V	22A	TO-220 AB	Q67040-A4423-A2

### Maximum Ratings

Parameter	Symbol	Values	Unit
Collector-emitter voltage	$V_{CE}$	600	V
Collector-gate voltage $R_{GE} = 20 \text{ k}\Omega$	$V_{CGR}$	600	
Gate-emitter voltage	$V_{GE}$	$\pm 20$	
DC collector current $T_C = 25 \text{ }^\circ\text{C}$ $T_C = 90 \text{ }^\circ\text{C}$	$I_C$	22 14	A
Pulsed collector current, $t_p = 1 \text{ ms}$ $T_C = 25 \text{ }^\circ\text{C}$ $T_C = 90 \text{ }^\circ\text{C}$	$I_{Cpuls}$	44 28	
Diode forward current $T_C = 90 \text{ }^\circ\text{C}$	$I_F$	11	
Pulsed diode current, $t_p = 1 \text{ ms}$ $T_C = 25 \text{ }^\circ\text{C}$	$I_{Fpuls}$	72	
Power dissipation $T_C = 25 \text{ }^\circ\text{C}$	$P_{tot}$	100	W
Chip or operating temperature	$T_j$	-55 ... + 150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 ... + 150	

## Maximum Ratings

Parameter	Symbol	Values	Unit
DIN humidity category, DIN 40 040	-	E	-
IEC climatic category, DIN IEC 68-1	-	55 / 150 / 56	

## Thermal Resistance

Thermal resistance, chip case	$R_{thJC}$	$\leq 1.25$	K/W
Diode thermal resistance, chip case	$R_{thJcD}$	$\leq 2.5$	

## Electrical Characteristics, at $T_j = 25\text{ }^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

## Static Characteristics

Gate threshold voltage $V_{GE} = V_{CE}, I_C = 0.35\text{ mA}$	$V_{GE(th)}$	4.5	5.5	6.5	V
Collector-emitter saturation voltage $V_{GE} = 15\text{ V}, I_C = 10\text{ A}, T_j = 25\text{ }^\circ\text{C}$	$V_{CE(sat)}$	-	2.1	2.7	
$V_{GE} = 15\text{ V}, I_C = 10\text{ A}, T_j = 125\text{ }^\circ\text{C}$		-	2.2	2.8	
$V_{GE} = 15\text{ V}, I_C = 20\text{ A}, T_j = 25\text{ }^\circ\text{C}$		-	3	-	
$V_{GE} = 15\text{ V}, I_C = 20\text{ A}, T_j = 125\text{ }^\circ\text{C}$		-	3.3	-	
Zero gate voltage collector current $V_{CE} = 600\text{ V}, V_{GE} = 0\text{ V}, T_j = 25\text{ }^\circ\text{C}$	$I_{CES}$	-	-	160	$\mu\text{A}$
Gate-emitter leakage current $V_{GE} = 25\text{ V}, V_{CE} = 0\text{ V}$	$I_{GES}$	-	-	100	nA

## AC Characteristics

Transconductance $V_{CE} = 20\text{ V}, I_C = 10\text{ A}$	$g_{fs}$	2	-	-	S
Input capacitance $V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1\text{ MHz}$	$C_{iss}$	-	570	760	pF
Output capacitance $V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1\text{ MHz}$	$C_{oss}$	-	80	120	
Reverse transfer capacitance $V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1\text{ MHz}$	$C_{rss}$	-	50	75	

### Electrical Characteristics, at $T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

### Switching Characteristics, Inductive Load at $T_j = 125\text{ °C}$

Turn-on delay time $V_{CC} = 300\text{ V}$ , $V_{GE} = 15\text{ V}$ , $I_C = 10\text{ A}$ $R_{Gon} = 100\text{ }\Omega$	$t_{d(on)}$	-	45	70	ns
Rise time $V_{CC} = 300\text{ V}$ , $V_{GE} = 15\text{ V}$ , $I_C = 10\text{ A}$ $R_{Gon} = 100\text{ }\Omega$	$t_r$	-	60	90	
Turn-off delay time $V_{CC} = 300\text{ V}$ , $V_{GE} = -15\text{ V}$ , $I_C = 10\text{ A}$ $R_{Goff} = 100\text{ }\Omega$	$t_{d(off)}$	-	250	340	
Fall time $V_{CC} = 300\text{ V}$ , $V_{GE} = -15\text{ V}$ , $I_C = 10\text{ A}$ $R_{Goff} = 100\text{ }\Omega$	$t_f$	-	500	680	

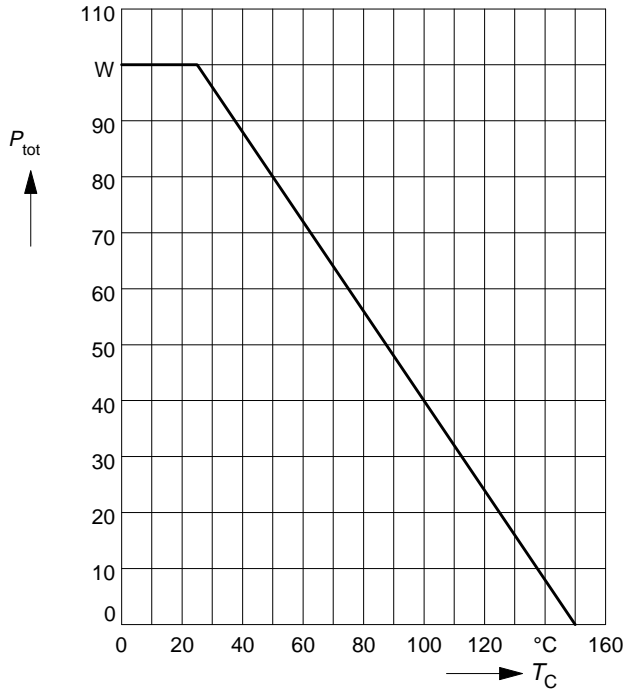
### Free-Wheel Diode

Diode forward voltage $I_F = 10\text{ A}$ , $V_{GE} = 0\text{ V}$ , $T_j = 25\text{ °C}$ $I_F = 10\text{ A}$ , $V_{GE} = 0\text{ V}$ , $T_j = 125\text{ °C}$	$V_F$	-	1.65	-	V
Reverse recovery time $I_F = 10\text{ A}$ , $V_R = -300\text{ V}$ , $V_{GE} = 0\text{ V}$ $di_F/dt = -100\text{ A}/\mu\text{s}$ $T_j = 25\text{ °C}$ $T_j = 125\text{ °C}$	$t_{rr}$	-	60	100	
Reverse recovery charge $I_F = 10\text{ A}$ , $V_R = -300\text{ V}$ , $V_{GE} = 0\text{ V}$ $di_F/dt = -100\text{ A}/\mu\text{s}$ $T_j = 25\text{ °C}$ $T_j = 125\text{ °C}$	$Q_{rr}$	-	0.2	0.37	$\mu\text{C}$
		-	0.4	0.74	

### Power dissipation

$$P_{\text{tot}} = f(T_C)$$

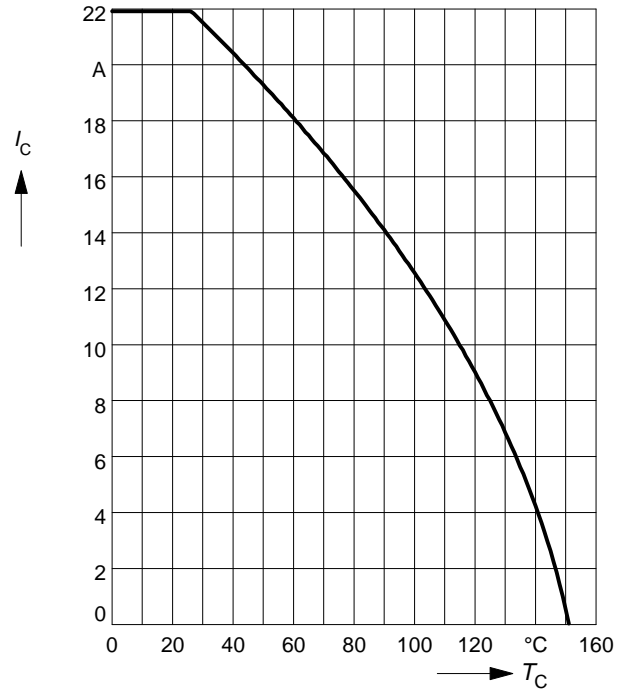
parameter:  $T_j \leq 150^\circ\text{C}$



### Collector current

$$I_C = f(T_C)$$

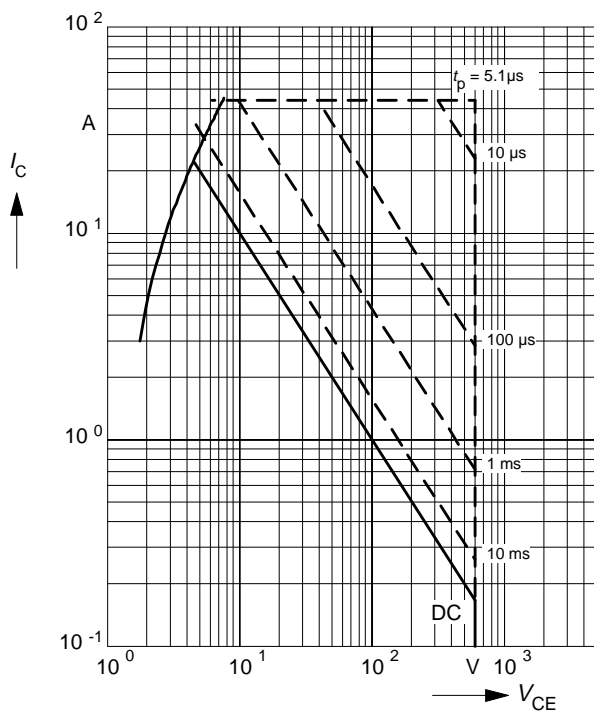
parameter:  $V_{\text{GE}} \geq 15\text{V}$ ,  $T_j \leq 150^\circ\text{C}$



### Safe operating area

$$I_C = f(V_{\text{CE}})$$

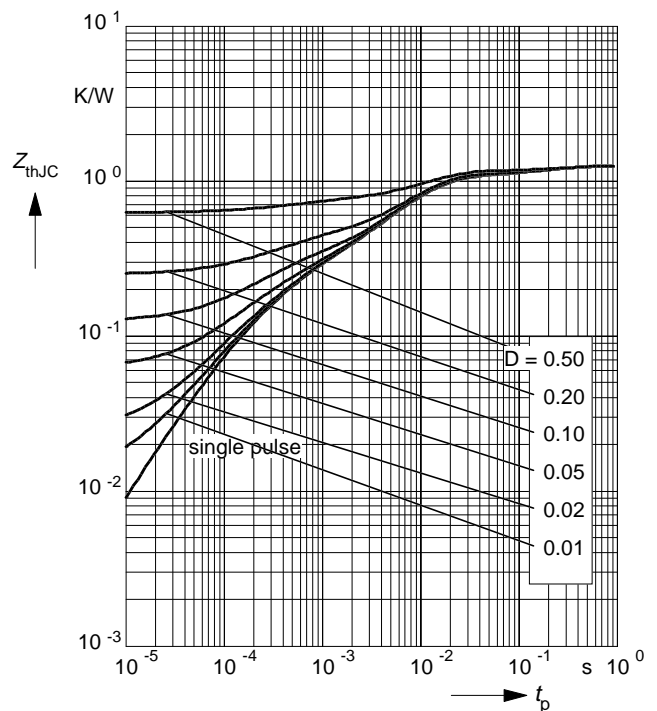
parameter:  $D = 0$ ,  $T_C = 25^\circ\text{C}$ ,  $T_j \leq 150^\circ\text{C}$



### Transient thermal impedance IGBT

$$Z_{\text{thJC}} = f(t_p)$$

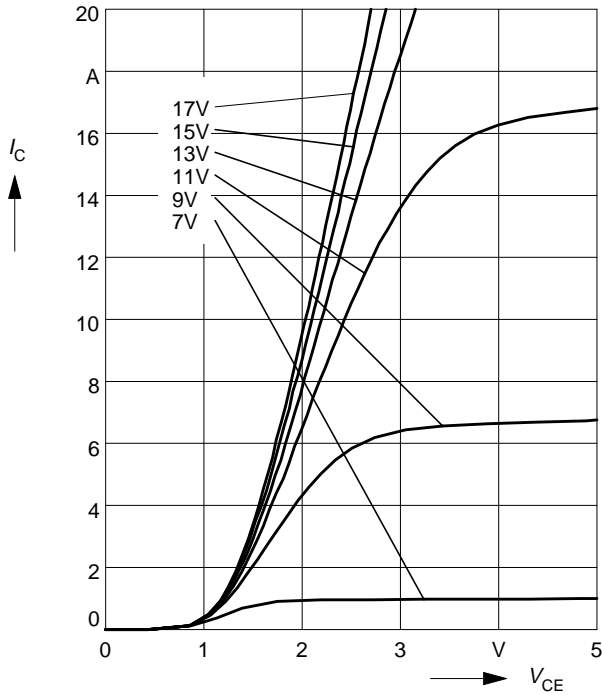
parameter:  $D = t_p / T$



### Typ. output characteristics

$$I_C = f(V_{CE})$$

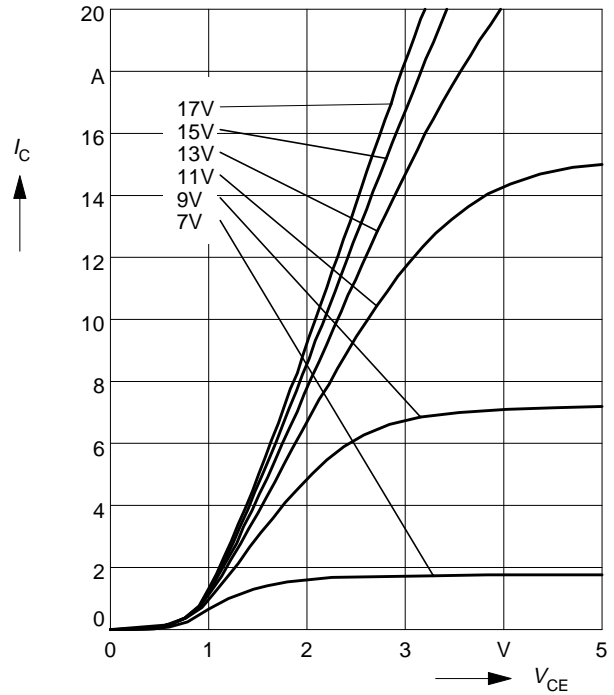
parameter:  $t_p = 80 \mu s, T_j = 25 \text{ }^\circ\text{C}$



### Typ. output characteristics

$$I_C = f(V_{CE})$$

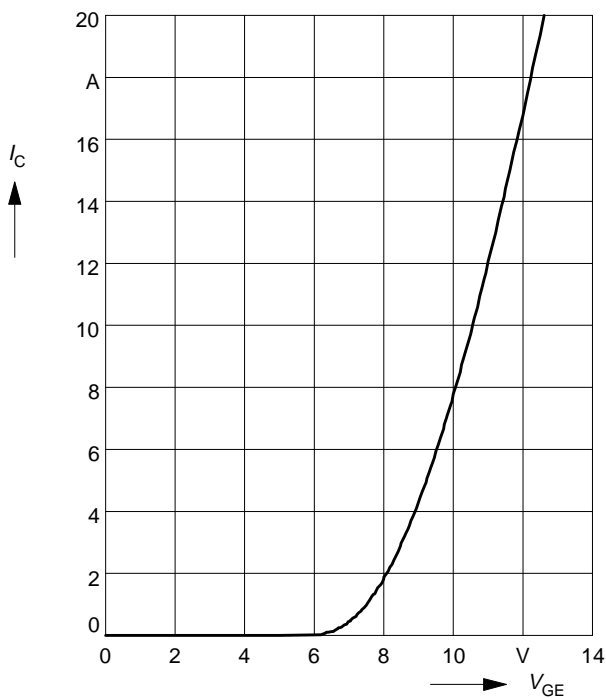
parameter:  $t_p = 80 \mu s, T_j = 125 \text{ }^\circ\text{C}$



### Typ. transfer characteristics

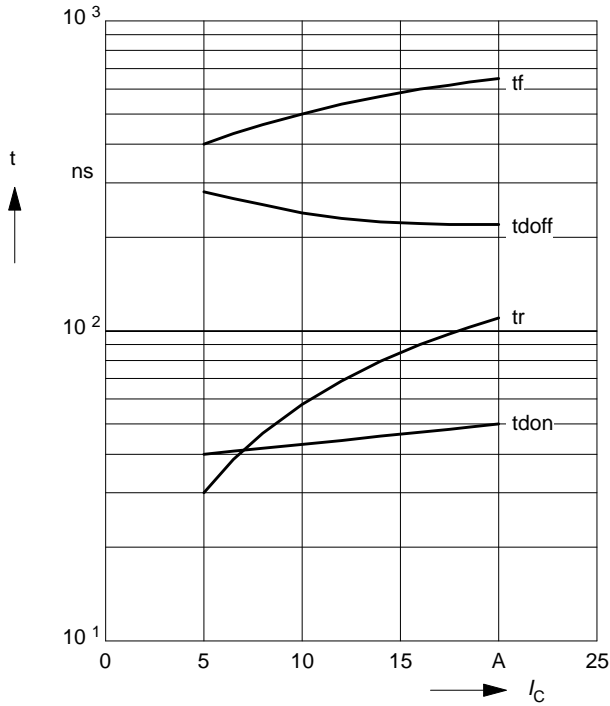
$$I_C = f(V_{GE})$$

parameter:  $t_p = 80 \mu s, V_{CE} = 20 \text{ V}$



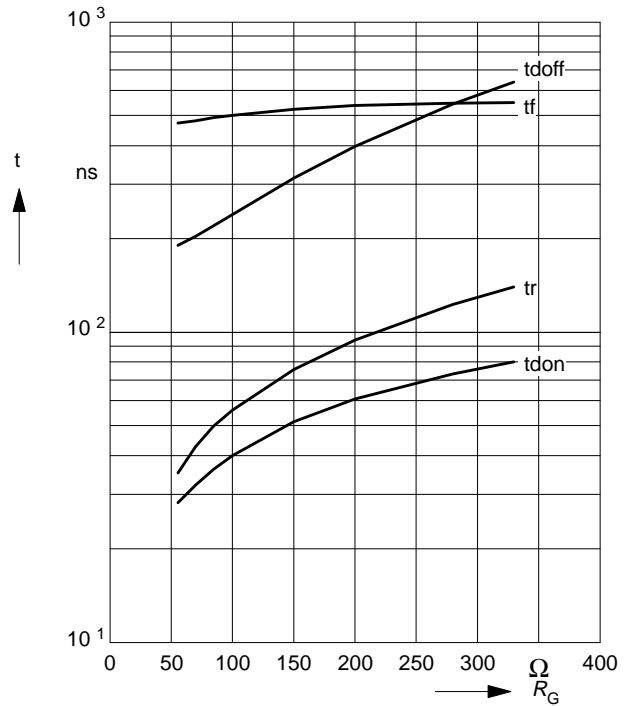
### Typ. switching time

$t = f(I_C)$ , inductive load,  $T_j = 125^\circ\text{C}$   
 par.:  $V_{CE} = 300\text{ V}$ ,  $V_{GE} = \pm 15\text{ V}$ ,  $R_G = 100\ \Omega$



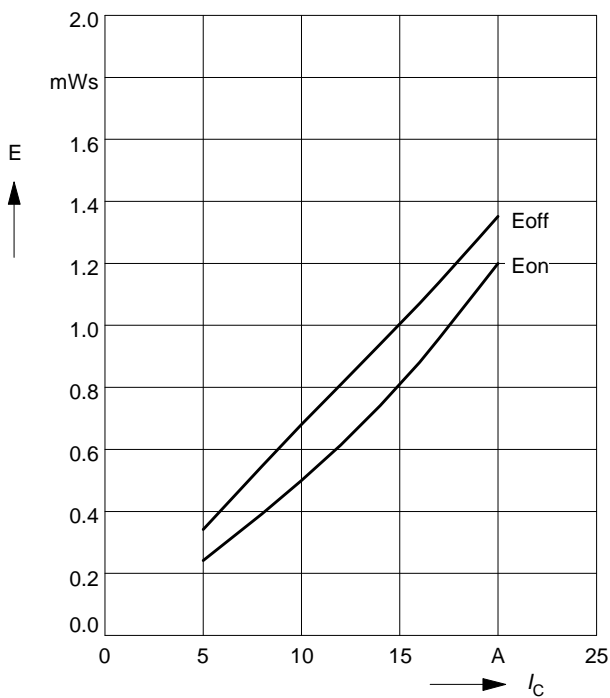
### Typ. switching time

$t = f(R_G)$ , inductive load,  $T_j = 125^\circ\text{C}$   
 par.:  $V_{CE} = 300\text{ V}$ ,  $V_{GE} = \pm 15\text{ V}$ ,  $I_C = 10\text{ A}$



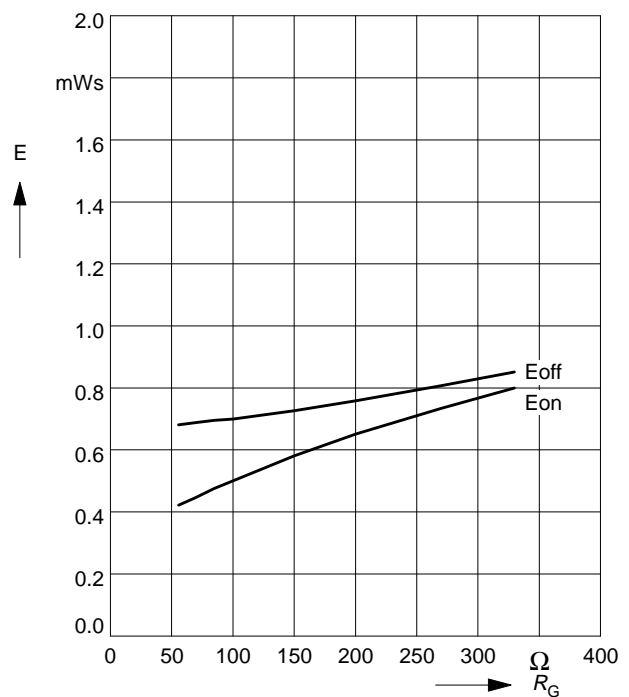
### Typ. switching losses

$E = f(I_C)$ , inductive load,  $T_j = 125^\circ\text{C}$   
 par.:  $V_{CE} = 300\text{ V}$ ,  $V_{GE} = \pm 15\text{ V}$ ,  $R_G = 100\ \Omega$



### Typ. switching losses

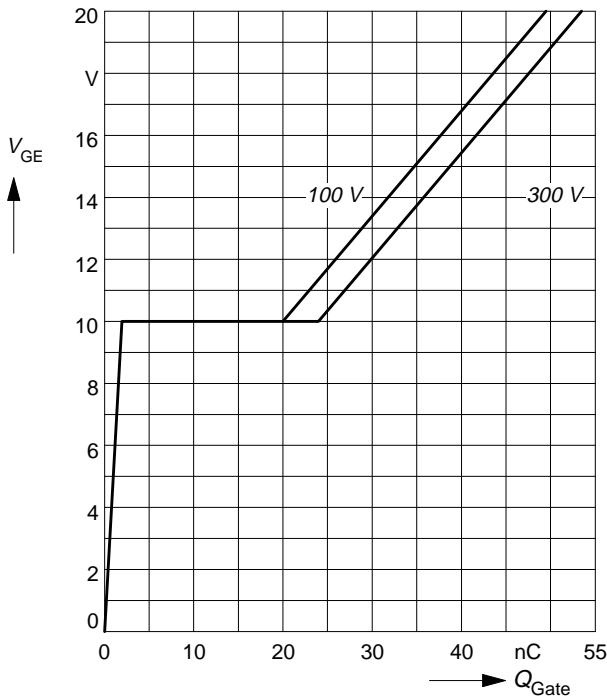
$E = f(R_G)$ , inductive load,  $T_j = 125^\circ\text{C}$   
 par.:  $V_{CE} = 300\text{ V}$ ,  $V_{GE} = \pm 15\text{ V}$ ,  $I_C = 10\text{ A}$



### Typ. gate charge

$$V_{GE} = f(Q_{Gate})$$

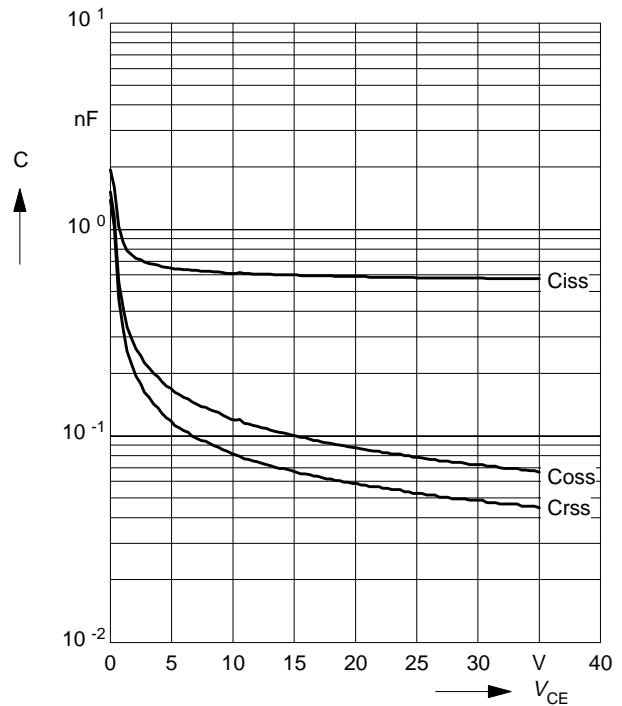
parameter:  $I_{C\ puls} = 10\ A$



### Typ. capacitances

$$C = f(V_{CE})$$

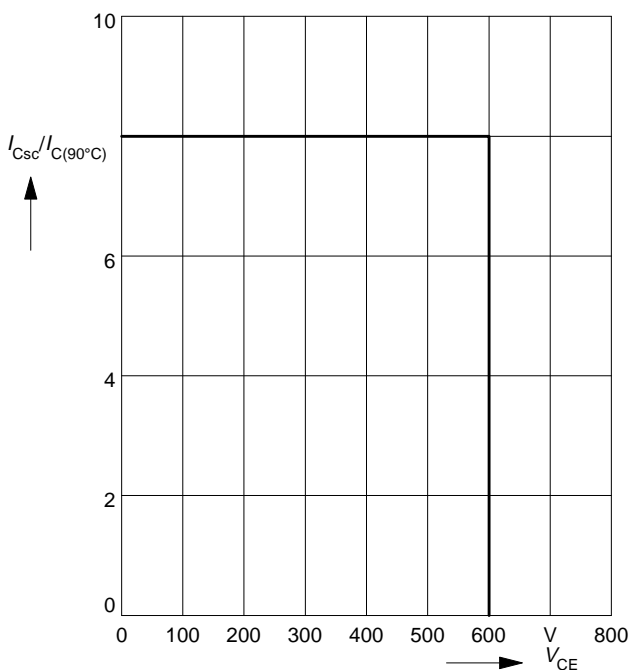
parameter:  $V_{GE} = 0\ V, f = 1\ MHz$



### Short circuit safe operating area

$$I_{Csc} = f(V_{CE}), T_j = 150^\circ C$$

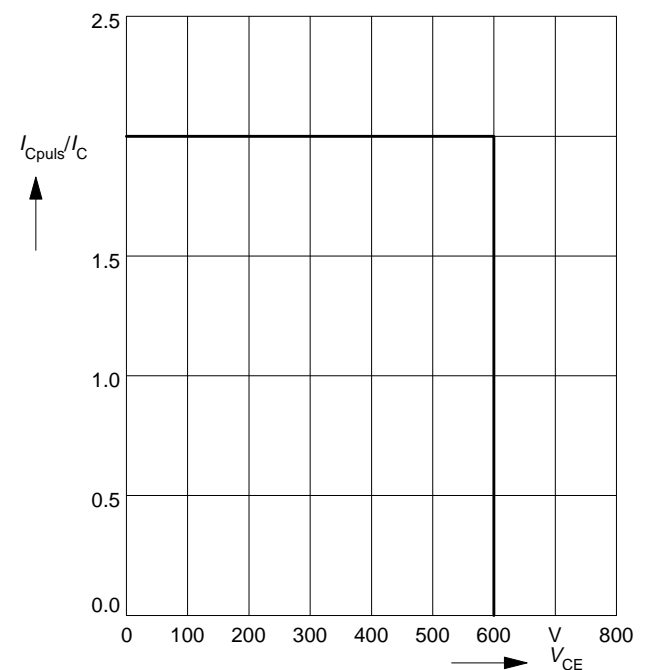
parameter:  $V_{GE} = \pm 15\ V, t_{sc} \leq 10\ \mu s, L < 50\ nH$



### Reverse biased safe operating area

$$I_{Cpuls} = f(V_{CE}), T_j = 150^\circ C$$

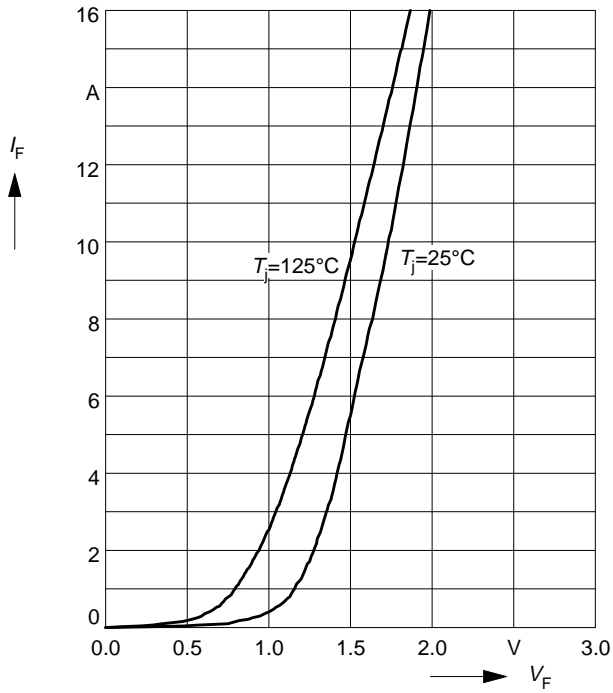
parameter:  $V_{GE} = 15\ V$



Typ. forward characteristics

$$I_F = f(V_F)$$

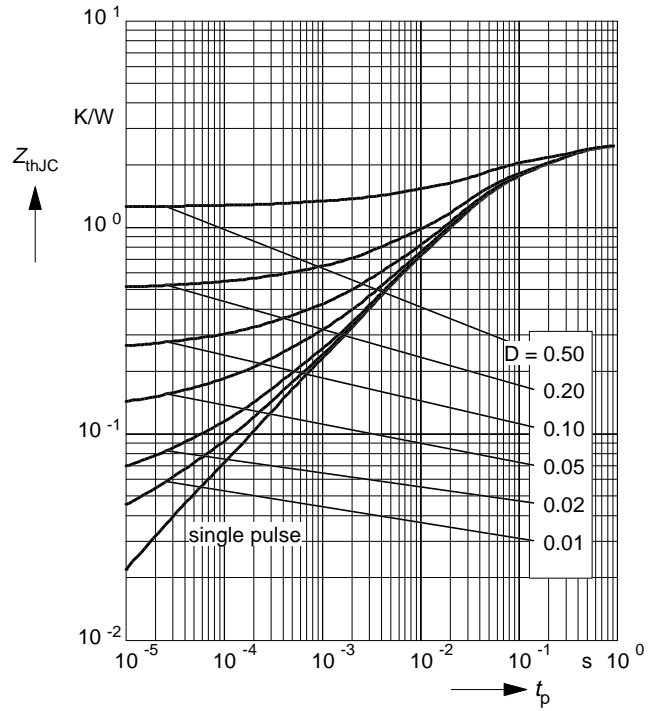
parameter:  $T_j$



Transient thermal impedance Diode

$$Z_{thJC} = f(t_p)$$

parameter:  $D = t_p / T$

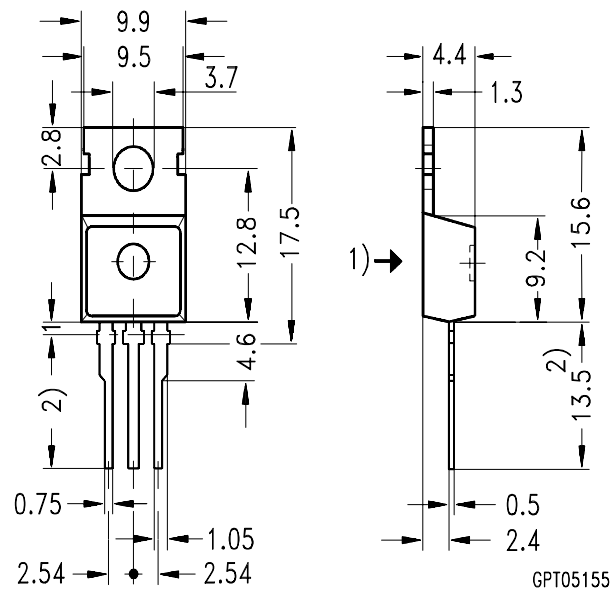




## Package Outlines

Dimensions in mm

Weight:



- 1) punch direction, burr max. 0.04
- 2) dip tinning
- 3) max. 14.5 by dip tinning press burr max. 0.05

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